

HIGH EFFICIENCY  
 FAST RECOVERY DIODES

**MAIN PRODUCT CHARACTERISTICS**

I <sub>F(AV)</sub>	25 A
V <sub>RRM</sub>	200 V
trr	50 ns
V <sub>F</sub>	0.85 V

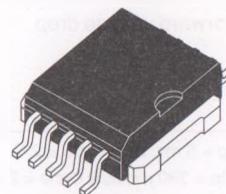
**FEATURES AND BENEFITS**

- VERY SMALL CONDUCTION LOSSES
- NEGLIGIBLE SWITCHING LOSSES
- LOW FORWARD AND REVERSE RECOVERY TIMES
- HIGH SURGE CURRENT
- HIGH DISSIPATION MINIATURE PACKAGE
- SURFACE MOUNT TECHNOLOGY COMPATIBLE

**DESCRIPTION**

Single rectifier suited for switchmode power supply and high frequency DC to DC converters.

Packaged in a high performance surface mount package PSO-10, this device is intended for use in high frequency inverters, free wheeling and polarity protection applications.



**Power SO-10™**  
 Plastic, non isolated SMD  
 with copper tab

**ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter		Value	Unit
V <sub>RRM</sub>	Repetitive peak reverse voltage		200	V
I <sub>F(RMS)</sub>	RMS forward current	(All pins connected)	44	A
I <sub>F(AV)</sub>	Average forward current	T <sub>c</sub> =125°C δ = 0.5	25	A
I <sub>FSM</sub>	Surge non repetitive forward current (All pins connected)	tp=10ms sinusoidal	200	A
I <sub>FRM</sub>	Repetitive peak forward current	tp = 5μs f = 5 kHz	310	A
T <sub>stg</sub> T <sub>j</sub>	Storage and junction temperature range		- 40 to + 150	°C

TM : PowerSO-10 is a trademark of SGS-THOMSON Microelectronics.

## THERMAL RESISTANCE

Symbol	Parameter	Value	Unit
R <sub>th</sub> (j-c)	Junction to case thermal resistance	1.0	°C/W

## STATIC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
I <sub>R</sub> *	Reverse leakage current	V <sub>R</sub> = V <sub>RRM</sub>	T <sub>j</sub> = 25°C			25	µA
			T <sub>j</sub> = 100°C			2.5	mA
V <sub>F</sub> **	Forward voltage drop	I <sub>F</sub> = 20 A	T <sub>j</sub> = 125°C			0.85	V
		I <sub>F</sub> = 40 A	T <sub>j</sub> = 125°C			1.05	
		I <sub>F</sub> = 40 A	T <sub>j</sub> = 25°C			1.15	

Pulse test : \* tp = 5 ms, duty cycle &lt; 2 %

\*\* tp = 380 µs, duty cycle &lt; 2 %

To evaluate the conduction losses use the following equation :

$$P = 0.65 \times I_{F(AV)} + 0.0075 I_{F(RMS)}$$

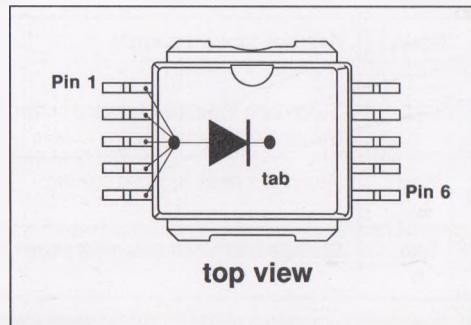
## RECOVERY CHARACTERISTICS

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
t <sub>rr</sub>	Reverse recovery time	T <sub>j</sub> = 25°C	I <sub>F</sub> = 0.5A			35	ns
		I <sub>rr</sub> = 0.25 A	I <sub>R</sub> = 1A			50	
		T <sub>j</sub> = 25°C	I <sub>F</sub> = 1A				
		dI <sub>F</sub> /dt = -50A/µs	V <sub>R</sub> = 30V				
t <sub>fr</sub>	Forward recovery time	T <sub>j</sub> = 25°C	I <sub>F</sub> = 1A		10		ns
		dI <sub>F</sub> /dt = 100A/µs					
		V <sub>FR</sub> = 1.1 x V <sub>F</sub> max					
V <sub>FP</sub>	Peak forward voltage	T <sub>j</sub> = 25°C	I <sub>F</sub> = 1A			1.5	V
		dI <sub>F</sub> /dt = 100A/µs					

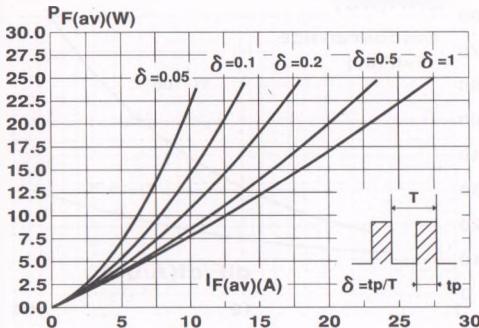
## PIN OUT configuration in PowerSO-10 :

Anode = pin 1 to 5

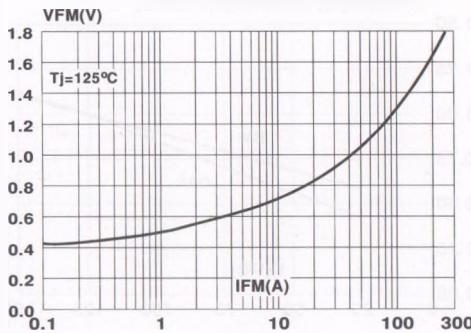
Cathode = connected to base tab



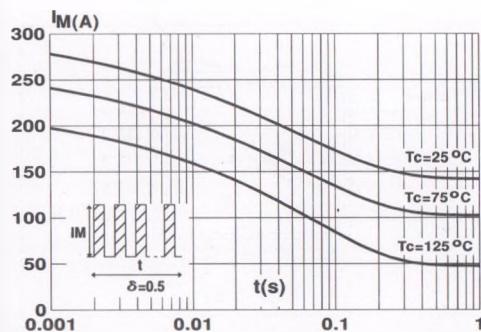
**Fig.1 : Average forward power dissipation versus average forward current.**



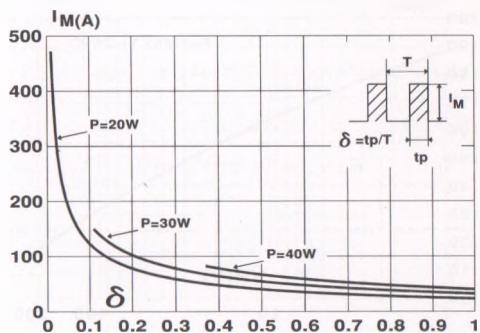
**Fig.3 : Forward voltage drop versus forward current (maximum values).**



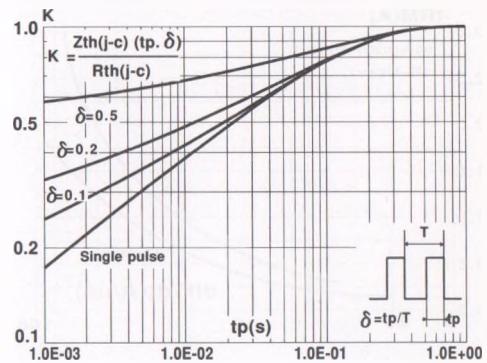
**Fig.5 : Non repetitive surge peak forward current versus overload duration.**



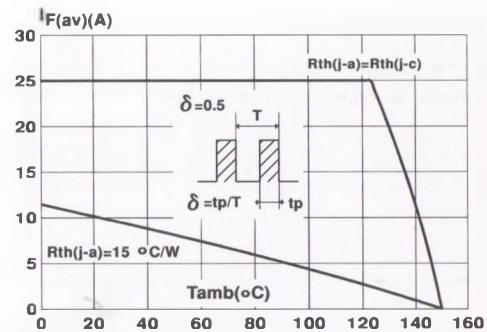
**Fig.2 : Peak current versus form factor.**



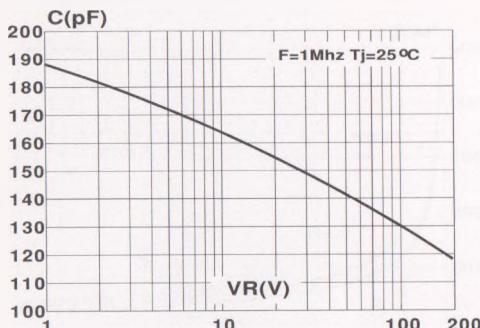
**Fig.4 : Relative variation of thermal impedance junction to case versus pulse duration.**



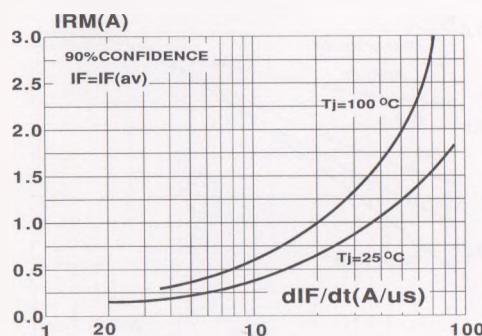
**Fig.6 : Average current versus ambient temperature. (duty cycle : 0.5)**



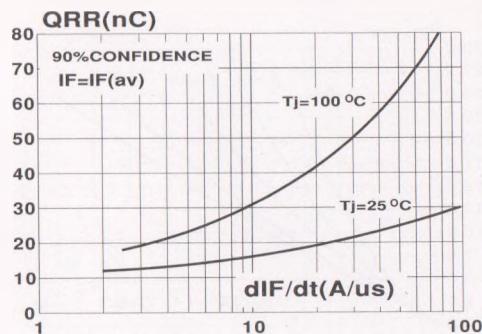
**Fig.7** : Junction capacitance versus reverse voltage applied (Typical values).



**Fig.9** : Peak reverse current versus  $dI/F/dt$ .



**Fig.8** : Recovery charges versus  $dI/F/dt$ .



**Fig.10** : Dynamic parameters versus junction temperature.

